DATA IMAGE CORPORATION

LCD Module Specification

ITEM NO.: TG126410FFNND-01

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2. RECORD OF REVISION

Rev	Date	Item	Page	Comment
Rev	Date JUL/19/02	Item 10	Page 12	Comment Change: P/N from TG12643FTH to TG126410FFNND-01

3. GENERAL SPECIFICATIONS

Display Format :	128 (W) × 64 (H) Dots
Dot Size :	0.38 (W) × 0.34 (H) mm
Dot Pitch	0.41 (W) × 0.37 (H) mm
View Area :	54 (W) × 31 (H) mm
General Dimensions :	58 (W) \times 54.6 (H) \times 2.1 (T) mm Max.
Weight :	10 g max.
LCD Type :	STN Gray STN Yellow VFSTN
Polarizer mode :	Reflective V Transflective
	Transmissive Negative
View Angle :	6 O'clock V 12 O'clock Others
Backlight :	LED EL CCFL
Backlight Color :	Yellow green Amber Blue Green
	White Others
Controller / Driver : Temperature Range :	SED1565 Normal V Wide Temperature Operating 0 to 50°C Operating -20to 70°C Storage -20 to 70°C Storage -30 to 80°C

4. ABSOLUTE MAXIMUM RATINGS

			Vss=	0V, Ta = 2	5°C
Item	Symbol	Min.	Max.	Unit	
Supply Voltage (Logic)	VDD-VSS	0	8	V	
Supply Voltage (LCD Driver)	VDD-VEE	0	16.5	V	
Input Voltage	Vi	VSS-0.3	VDD+0.3	V	
Operating Temperature	Тор	-20	70	°C	
Storage Temperature	Tstg	-30	80	°C	

4.1 ELECTRICAL ABSOLUTE MAXIMUM RATINGS

4.2 ENVIRONMENTAL ABSOLUTE MAXIMUM RATINGS

ltem	Oper	ating	Storage		Storage		Comment
nem	(Min.)	Max.)	(Min.)	(Max.)	Comment		
Ambient Temp	-20	70	-30	80	Note (1)		
Humidity	Note	e (2)	Note(2)		Without Condensation		
Vibration		4.9M/S ²		19.6M/S ²	XYZ Direction		
Shock		29.4M/S ²		490M/S ²	XYZ Direction		

Note(1) Ta = $0^{\circ}C$: 50Hr Max.

Note(2) Ta $\leq 40^{\circ}$ C : 90% RH Max.

Ta $\geq 40^{\circ}$ C : Absolute humidity must be lower than the humidity of 90% RH at 40°C.

5. ELECTRI CAL CHARACTERI STI CS

Item	Symbol	Condition	Min.	Тур.	Max.	Unit
Supply Voltage (Logic)	VDD-VSS		2.7	3.0	5.0	V
		-20°C	8.9	9.5	10.2	
Supply Voltage (LCD)	VDD-VEE	25°C	8.2	8.8	9.4	V
		70°C	7.5	8.0	8.6	
	Vін		VSS+2.0		Vdd	V
Input Voltage	VIL		Vss		VSS+0.8	V
Logic Supply Current	Idd	VDD-VSS=3V		0.9		mA

6. ELECTRO-OPTI CAL CHARACTERI STI CS

ITEM	Symbol	Condition	Min.	Тур.	Max.	Unit	Ref.
		-20°C		4600	6900		
Rise Time	Tr	0°C		700	1050	ms	
		25°C		180	270		Note (1)
		-20°C		16100	24150		Note (1)
Fall Time	Tf	0°C		1800	2700	ms	
		25°C		500	750		
Contrast	CR	25°C		5			Note (3)
View Angle	θ1~θ2	25°C	40			Dograa	Note (2)
view Angle	Ø1, Ø2	250	40			Degree	Note (2)
Frame Frequency	Ff	25°C		78		Hz	

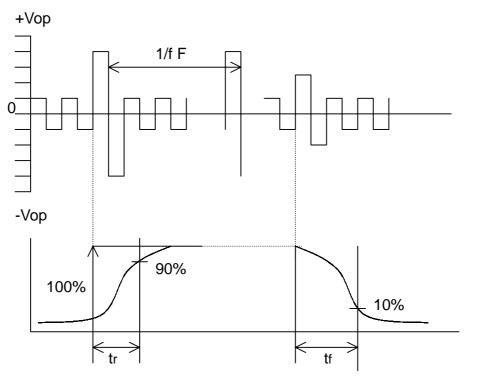
Note (1) & (2) : See next page

Note (3) : Contrast ratio is defined under the following condition:

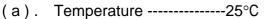
CR= Brightness of non-selected condition Brightness of selected condition

- (a). Temperature ----- 25°C
- (b). Frame frequency ---- 78Hz
- (c). Viewing angle ----- $\theta = 0^{\circ}, \emptyset = 0^{\circ}$
- (d). Operating voltage --- 8.8V

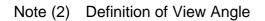
Note (1) Response time is measured as the shortest period of time possible between the change in state of an LCD segment as demonstrated below:

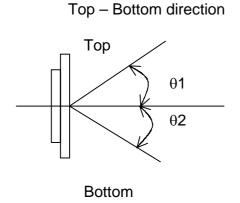


Condition:

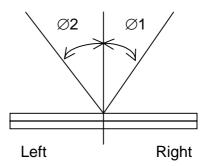


- (b). Frame frequency ----- 78Hz
- (c). View Angle ----- $\theta = 0^\circ, \emptyset = 0^\circ$
- (d). Operating voltage ----- 8.8V



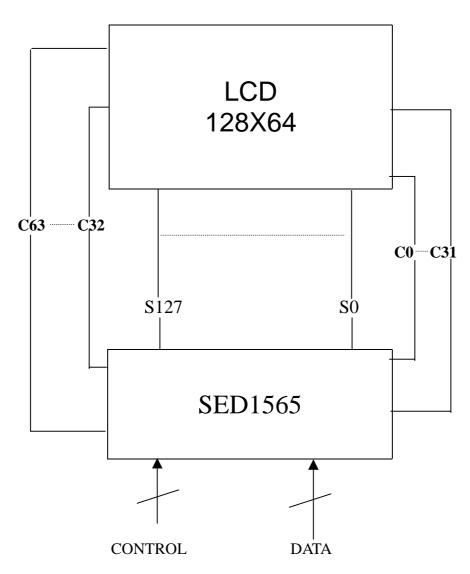






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7. BLOCK DIAGRAM



8. QUALITY ASSURANCE

8.1 Test Condition

8.1.1 Temperature and Humidity(Ambient Temperature)

Temperature	:	$20 \pm 5^{\circ}C$
Humidity	:	$65 \pm \mathbf{5\%}$

8.1.2 Operation

Unless specified otherwise, test will be conducted with LCM in operation.

8.1.3 Container

Unless specified otherwise, vibration test will be conducted on module only.

8.1.4 Test Frequency Single cycle.

8.1.5 Test Method

No.	Parameter	Conditions	Regulations
1	High Temperature Operating	70 ± 2 °C	Note 3
2	Low Temperature Operating	-20 ± 2 °C	Note 3
3	High Temperature Storage	80 ± 2 °C	Note 3
4	Low Temperature Storage	-30 ± 2 °C	Note 3
5	Vibration Test (Non-operation state)	Total fixed amplitude : 1.5mm Vibration Frequency : 10 ~ 55Hz One cycle 60 seconds to 3 directions of X.Y.Z. for each 15 minutes	Note 3
6	Damp Proof Test (Non-operation state)	40°C ± 2°C, 90~95%RH, 96h	Note 1,2
7	Shock Test (Non-operation state)	To be measured after dropping from 60cm high once concrete surface in packing state	Note 3

Note 1: Returned under normal temperature and humidity for 4 hours.

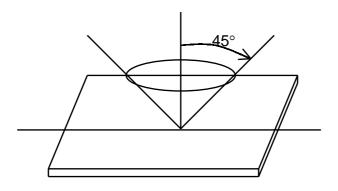
Note 2: No dew condensation to be observed.

Note 3: No change on display and in operation under the test condition

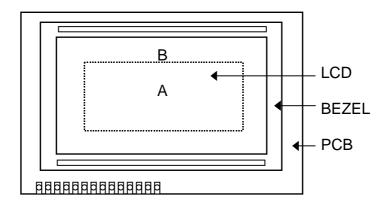
8.2 Inspection condition

8.2.1 Inspection conditions

The LCD shall be inspected under 40W white fluorescent light.



8.2.2 Definition of applicable Zones

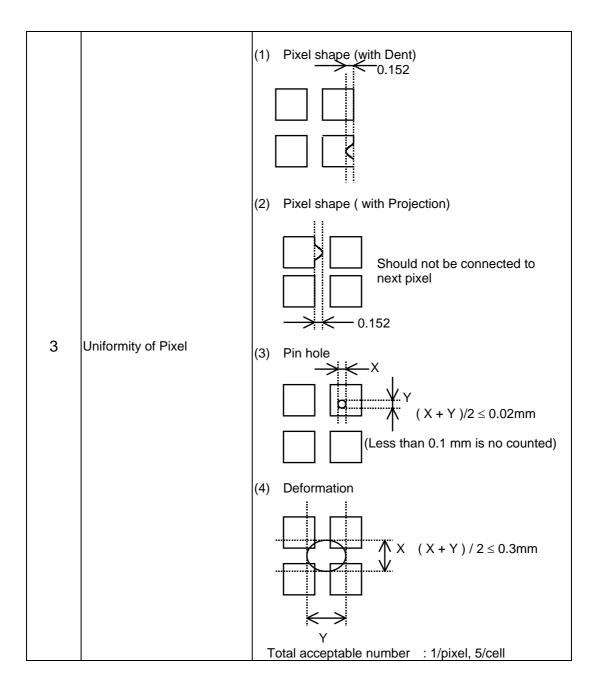


A : Display Area

B : Non-Display Area

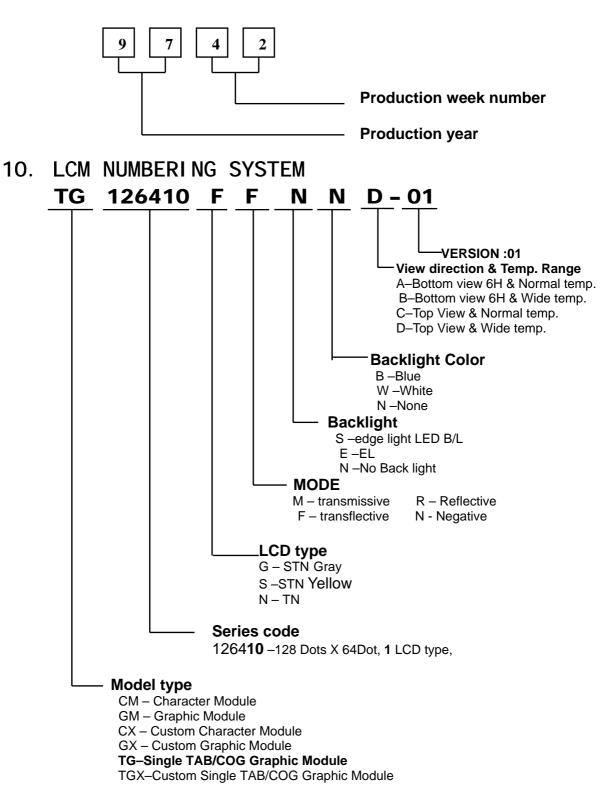
8.2.3 Inspection Parameters

No.	Parameter	Criteria
1	Black or White spots	
		Zone Acceptable Class AQL number Of Level
		$\begin{array}{ c c c c c c c c } \hline Dimension & A & B & Defects & Level \\ \hline D < 0.15 & * & * & & \\ \hline 0.15 \leq D < 0.2 & 4 & 4 & & \\ \hline 0.2 \leq D \leq 0.25 & 2 & 2 & & \\ \hline D \leq 0.3 & 0 & 1 & & & \\ \hline D = (Long + Short) / 2 & * : Disregard & & \\ \hline \end{array}$
2	Scratch, Substances	
		ZoneAcceptableClassAQLnumberOfLevelX (mm)Y(mm)ABDefects
		$\begin{array}{c ccccccccccccccccccccccccccccccccccc$
		X : Length Y : Width * : Disregard Total defects should not exceed 4/module
3	Air Bubbles (between glass & polarizer)	
		ZoneAcceptableClassAQLnumberofLevelDimensionABDefects
		$\begin{array}{ c c c c c c c }\hline D \leq 0.15 & * & * & \\ \hline 0.15 < D \leq 0.25 & 2 & * & \\ \hline 0.25 < D & 0 & 1 & \\ \hline \end{array} Minor \qquad 2.5$
		* : Disregard Total defects shall not excess 3/module.



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9. LOT NUMBERING SYSTEM



11. PRECAUTION FOR USING LCM

1. LIQUID CRYSTAL DISPLAY (LCD)

LCD is made up of glass, organic sealant, organic fluid, and polymer based polarizers. The following precautions should be taken when handing,

(1). Keep the temperature within range of use and storage. Excessive temperature and humidity could cause

polarization degredation, polarizer peel off or bubble.

(2). Do not contact the exposed polarizers with anything harder than an HB pencil lead. To clean dust off the display surface, wipe gently with cotton, chamois or other soft material soaked in petroleum benzin.

(3). Wipe off saliva or water drops immediately. Contact with water over a long period of time may cause polarizer deformation or color fading, while an active LCD with water condensation on its surface will cause corrosion of ITO electrodes.

(4). Glass can be easily chipped or cracked from rough handling, especially at corners and edges.

(5). Do not drive LCD with DC voltage.

2. Liquid Crystal Display Modules

2.1 Mechanical Considerations

LCM are assembled and adjusted with a high degree of precision. Avoid excessive shocks and do not make any alterations or modifications. The following should be noted. (1). Do not tamper in any way with the tabs on the metal frame.

(2). Do not modify the PCB by drilling extra holes, changing its outline, moving its components or modifying its pattern.

(3). Do not touch the elastomer connector, especially insert an backlight panel (for example, EL).

(4). When mounting a LCM make sure that the PCB is not under any stress such as bending or twisting . Elastomer contacts are very delicate and missing pixels could result from slight dislocation of any of the elements.

(5). Avoid pressing on the metal bezel, otherwise the elastomer connector could be deformed and lose contact, resulting in missing pixels.

2.2. Static Electricity

LCM contains CMOS LSI's and the same precaution for such devices should apply, namely

(1). The operator should be grounded whenever he/she comes into contact with the module. Never touch any of the conductive parts such as the LSI pads, the copper leads on the PCB and the interface terminals with any parts of the human body.

(2). The modules should be kept in antistatic bags or other containers resistant to static for storage.

(3). Only properly grounded soldering irons should be used.

(4). If an electric screwdriver is used, it should be well grounded and shielded from commutator sparks.

(5) The normal static prevention measures should be observed for work clothes and working benches; for the latter conductive (rubber) mat is recommended.(6). Since dry air is inductive to static, a relative humidity of 50-60% is recommended.

2.3 Soldering

(1). Solder only to the I/O terminals.

(2). Use only soldering irons with proper grounding and no leakage.

(3). Soldering temperature : $280^{\circ}C \pm 10^{\circ}C$

(4). Soldering time: 3 to 4 sec.

(5). Use eutectic solder with resin flux fill.

(6). If flux is used, the LCD surface should be covered to avoid flux spatters. Flux residue should be removed after wards.

2.4 Operation

(1). The viewing angle can be adjusted by varying the LCD driving voltage V0.

(2). Driving voltage should be kept within specified range; excess voltage shortens display life.

(3). Response time increases with decrease in temperature.

(4). Display may turn black or dark blue at temperatures above its operational range; this is (however not pressing on the viewing area) may cause the segments to appear "fractured".

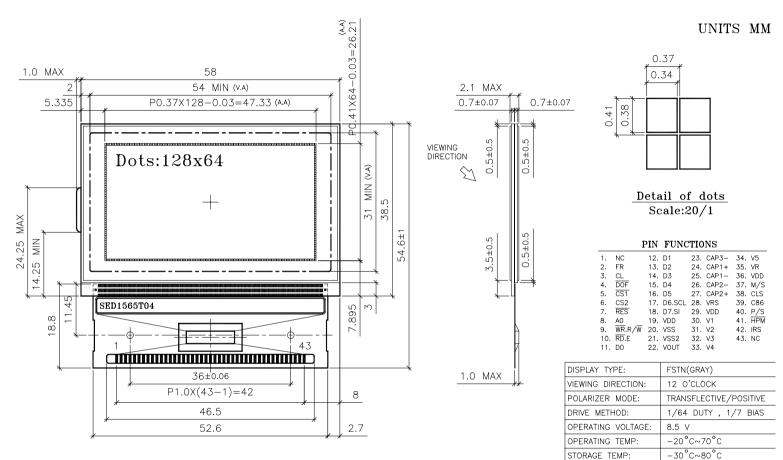
(5). Mechanical disturbance during operation (such as pressing on the viewing area) may cause the segments to appear "fractured".

2.5 Storage

If any fluid leaks out of a damaged glass cell, wash off any human part that comes into contact with soap and water. Never swallow the fluid. The toxicity is extremely low but caution should be exercised at all the time.

2.6 Limited Warranty

Unless otherwise agreed between DATA IMAGE and customer, DATA IMAGE will replace or repair any of its LCD and LCM which is found to be defective electrically and visually when inspected in accordance with DATA IMAGE acceptance standards, for a period on one year from date of shipment. Confirmation of such date shall be based on freight documents. The warranty liability of DATA IMAGE is limited to repair and/or replacement on the terms set forth above. DATA IMAGE will not responsible for any subsequent or consequential events.



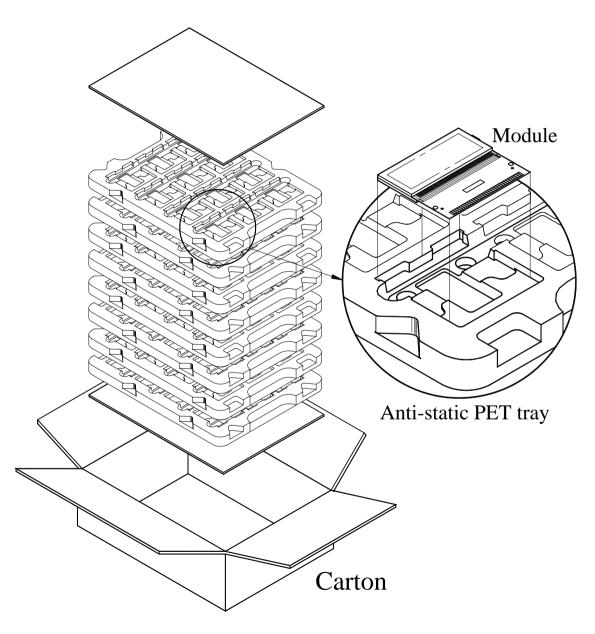
12. OUTLINE DRAWING

Note: tolerance is ± 0.2 unless otherwise noted.

TAB IC

CONNECTOR:

13. PACKAGE INFORMATION



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14. IC CONTENTS ATTACHMENT:

Reference Documents From EPSON SED1565 LCD DRIVER With

contents

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